

Electrical, Thermal, and Thermoelectric Transport Properties of Co-Doped *n*-type $\text{Cu}_{0.008}\text{Bi}_2\text{Te}_{2.6}\text{Se}_{0.4}$ Polycrystalline Alloys

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Abstract: Bi_2Te_3 -based alloys have been extensively studied as thermoelectric materials near room temperature. In this study, the electrical, thermal, and thermoelectric transport properties of a series of Co-doped *n*-type $\text{Cu}_{0.008}\text{Bi}_2\text{Te}_{2.6}\text{Se}_{0.4}$ polycrystalline alloys ($\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$, $x = 0, 0.03, 0.06, 0.09$ and 0.12) are investigated. The electrical conductivity of the $\text{Cu}_{0.008}\text{Bi}_{1.97}\text{Co}_{0.03}\text{Te}_{2.6}\text{Se}_{0.4}$ ($x = 0.03$) sample was significantly enhanced, by 34%, to 1199 S/cm compared to 793 S/cm of the pristine $\text{Cu}_{0.008}\text{Bi}_2\text{Te}_{2.6}\text{Se}_{0.4}$ ($x = 0$) sample at 300 K, and gradually decreased to 906 S/cm for $x = 0.12$ upon further doping. Power factors of the Co-doped samples decreased compared to the 3.26 mW/mK² of the pristine $\text{Cu}_{0.008}\text{Bi}_2\text{Te}_{2.6}\text{Se}_{0.4}$ sample at 300 K. Meanwhile, the power factor of the $\text{Cu}_{0.008}\text{Bi}_{1.97}\text{Co}_{0.03}\text{Te}_{2.6}\text{Se}_{0.4}$ ($x = 0.03$) sample became higher at 520 K. The lattice thermal conductivities of the Co-doped samples decreased due to additional point defect phonon scattering by the Co dopant. Consequently, the zT for the $\text{Cu}_{0.008}\text{Bi}_{1.97}\text{Co}_{0.03}\text{Te}_{2.6}\text{Se}_{0.4}$ alloy at 520 K was 0.83, which is approximately 15% larger than that of pristine $\text{Cu}_{0.008}\text{Bi}_2\text{Te}_{2.6}\text{Se}_{0.4}$, while the zT of the Cu doped samples at 300 K was smaller than that of the pristine $\text{Cu}_{0.008}\text{Bi}_2\text{Te}_{2.6}\text{Se}_{0.4}$ sample. Electrical transport properties of the Co-doped $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ samples were analyzed by experimental phenomenological parameters, including the density-of-state, effective mass, weighted mobility, and quality factor.

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Keywords: thermoelectric, Bi_2Te_3 , doping

1. INTRODUCTION

Bi_2Te_3 -based alloys have been extensively studied as thermoelectric materials at room temperature. These materials are semiconductors with a narrow band gap (~ 0.13 eV) [1,2]. They have excellent electrical transport properties with a high carrier concentration ($\sim 10^{19}$ cm⁻³) and exhibit a relatively low thermal conductivity due to layered structures with a weak Van der Waals bonding between layers [3-5], resulting in a good thermoelectric figure of merit (zT) at room temperature [6,7]. Thermoelectric performance is evaluated by the dimensionless Figure of merit, $zT = S^2\sigma T/\kappa_{tot}$

where S , σ , T , and κ_{tot} are Seebeck coefficient, electrical conductivity, absolute temperature, and total thermal conductivity ($\kappa_{tot} = \kappa_{ele} + \kappa_{latt}$, where κ_{ele} and κ_{latt} are electron and lattice thermal conductivities, respectively), respectively. At elevated temperatures Bi_2Te_3 -based alloys also induce an intrinsic excitation of electron-hole pairs, resulting in a decrease in S and an increase in κ_{tot} . Therefore, Bi_2Te_3 -based alloys exhibit rapidly degrading thermoelectric performance above 500 K [8-10], which limits the application of Bi_2Te_3 alloys to low temperatures, of 450 K or less.

Pristine Bi_2Te_3 is an *n*-type semiconductor and is typically doped with Se into the Te-site to improve its thermoelectric performance. However, Bi_2Te_3 compositions exhibit unstable carrier transport properties because of self-defects, the formation of anti-site defects, and Te-site vacancies [11]. The unstable carrier transport properties of *n*-type $\text{Bi}_2\text{Te}_{3-x}\text{Se}_x$ can be stabilized by adding Cu [12-15].

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- 박옥민: 석사과정, 허민수 · 박상정 · 이세웅 · 조현규: 학부과정, 김태완 · 김상일: 부교수

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Defect engineering, such as doping, addition, and solid-solution, are the most used strategies for reducing κ_{latt} by promoting point defect phonon scattering [16-19]. Doping strategies have been widely applied to enhance the thermoelectric transport properties of thermoelectric materials, particularly the n-type Bi_2Te_3 -based alloys [19-22]. Lee et al. reported that using I-doping to improve the carrier transport properties of $\text{Cu}_{0.008}\text{Bi}_2\text{Te}_{2.7}\text{Se}_{0.3}$ enhanced zT to 0.86 at 400 K [21]. A higher zT of 1.07 at 423 K was observed in CuI-doped $\text{Bi}_2\text{Te}_{2.7}\text{Se}_{0.3}$ processed by hot-deformation [22]. Similarly, Co doping was used to enhance the electrical transport properties of pristine Bi_2Te_3 and p-type $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$ [23,24].

However, Co-doping to $\text{Bi}_2\text{Te}_{3-x}\text{Se}_x$, a representative type of n-type Bi_2Te_3 based alloy, has not yet been reported. Therefore, in this study, the electrical, thermal, and thermoelectric transport properties of $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ ($x = 0, 0.03, 0.06, 0.09$ and 0.12) polycrystalline bulk alloys were investigated. The electrical transport properties of a Co-doped $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ composition were analyzed by experimental phenomenological parameters, including the density-of-state effective mass (m_d^*), weighted mobility (μ_w), and quality factor (B).

2. EXPERIMENTAL

Polycrystalline $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ ($x = 0, 0.03, 0.06, 0.09$ and 0.12) samples were prepared via the solid-state reaction method. Stoichiometric ratios of high purity Bi (99.999%, 5N Plus), Te (99.999 %, 5N Plus), and Co (99.99%, Sigma Aldrich) were sealed in a quartz tube under a pressure of 10^{-5} Torr to prevent oxidation or other reactions with air. The raw materials placed in the sealed quartz ampoules were synthesized at 1323 K for 12 h (heating rate of 3 K/min), and then slowly cooled in a box furnace. The synthesized ingots were pulverized for 5 min via high energy ball milling (SPEX 8000D, SPEX) in an Ar atmosphere. The powders placed in the graphite molds were sintered using spark plasma sintering (SPS-1030, Sumitomo Coal Mining Co., Ltd.) under 10^{-6} Torr at 707 K for 5 min (heating rate = 100 K/min) under 70 MPa. The sintered bulk samples had relative densities of more than $\sim 99\%$.

X-Ray diffraction (XRD, D8 Discover, Bruker) analysis

was performed to analyze the crystal structure of the samples. The polycrystalline powder samples were excited with 0.154 nm wavelength Cu-K α radiation. For the σ and S measurements, the sintered samples were processed into rectangular shapes with dimensions of 2 mm \times 2 mm \times 8 mm. The processed specimens were analyzed using ZEM-3 (Advanced-Riko) in the temperature range 300–520 K in a He atmosphere, and the power factor was calculated using the measured σ and S . The Hall carrier concentrations (n_{H}) and Hall carrier mobilities (μ_{H}) were measured using a Hall measurement system (HMS5300, Ecopia) under a magnetic field of 0.548 T; the Hall measurements were performed using the van der Pauw configuration. The laser flash method (LFA457, Netzsch) was performed to obtain the thermal diffusivity (α) required to calculate κ_{tot} ($\kappa_{\text{tot}} = \alpha \times \rho_s \times C_p$, where ρ_s and C_p are the sample density and heat capacity, respectively). The ρ_s value is the theoretical density of $\text{Bi}_2\text{Te}_{2.6}\text{Se}_{0.4}$ —assuming a linear increase in the Bi_2Te_3 (7.834 g/cm 3)– Bi_2Se_3 (7.664 g/cm 3) system. The C_p value of Bi_2Te_3 was determined from the empirical formulas of $108.06 + 5.53 \times 10^{-2} T$ J/mol·K and C_p of $\text{Bi}_2\text{Se}_3 = 118.61 + 1.92 \times 10^{-2} T$ J/mol·K [25]. The zT value was evaluated using the calculated power factor and κ_{tot} .

3. RESULTS AND DISCUSSION

The XRD patterns for the $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ powder samples indicated a single rhombohedral Bi_2Te_3 phase without any additional phases (Figure 1(a)). The lattice parameters, a and c were calculated using the (015) and (1010) diffraction peaks (Figure 1(b)). The calculated lattice parameters gradually decreased with an increase in x values; a decreased from 4.365 to 4.348 Å and c decreased from 30.390 to 30.323 Å. This is because Co is substituted and doped at the Bi-site, that is, a Co-cation (~ 88.5 pm) with a relatively small ionic radius replaced the Bi^{+3} (117 pm).

Figures 2(a) and 2(b) show σ and S as a function of temperature, respectively, for the polycrystalline bulk samples along the direction perpendicular to the sintering pressure. The σ values of the Co-doped samples were higher than those of the undoped sample at all temperature ranges, and all samples exhibited intrinsic metal behavior. As shown in the inset of Figure 2(a), the σ values for $x = 0, 0.03, 0.06,$

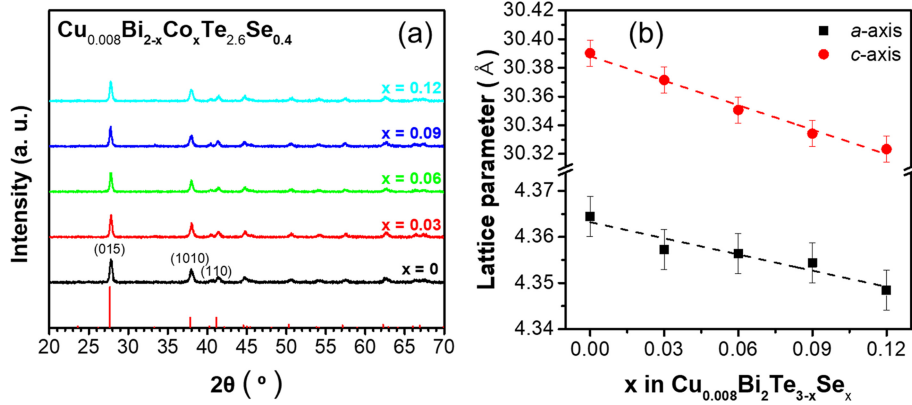


Fig. 1. (a) XRD patterns and (b) lattice parameters of the $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ ($x = 0, 0.03, 0.06, 0.09$ and 0.12) polycrystalline bulk alloys.

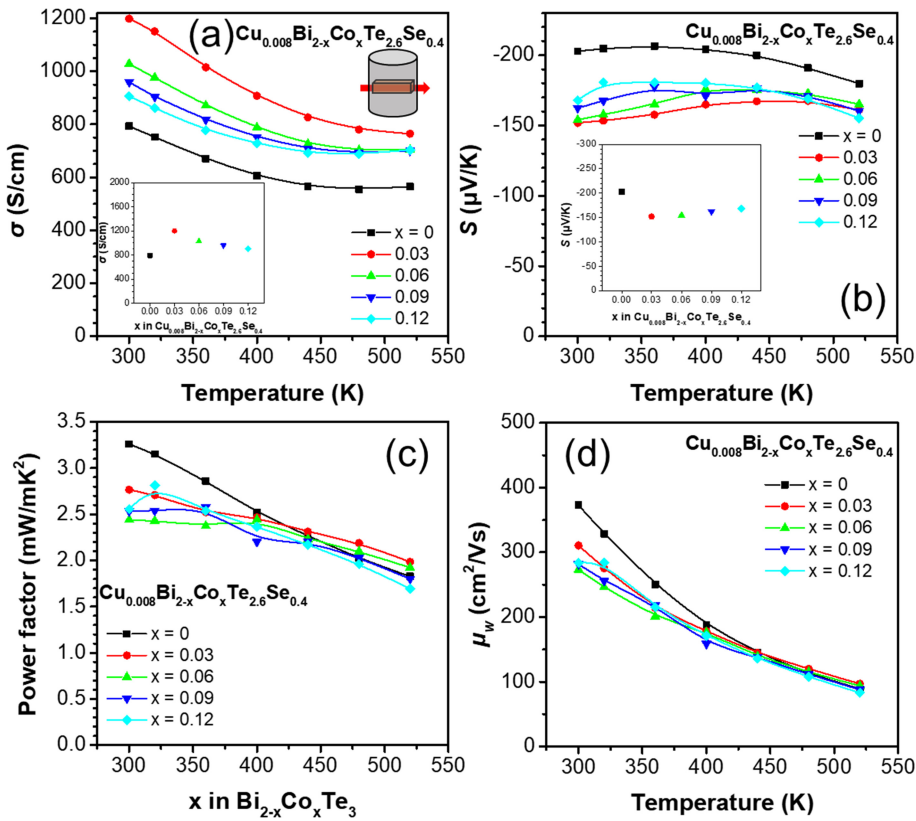


Fig. 2. (a) σ , (b) S , (c) power factor, and (d) μ_w as a function of the temperature for the $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ ($x = 0, 0.03, 0.06, 0.09$ and 0.12) polycrystalline bulk alloys. Insets of (a) σ and (b) S as a function of x content at 300 K.

0.09, and 0.12 were 793, 1199, 1028, 960, and 906 S/cm, respectively, at 300 K. Remarkably, the σ values systemically decreased with increases in doping level, after abruptly increasing at $x = 0.03$. The S values were similar even with the increase in temperature with a decrease in the doped samples, owing to the trade-off relationship between σ and S .

Therefore, the S values showed the opposite trend compared to σ . The S values for $x = 0, 0.03, 0.06, 0.09$, and 0.12 were $-202, -152, -154, -163$, and -168 $\mu\text{V/K}$ (inset of Figure 2(b)), respectively, at 300 K.

Figures 2(c) and 2(d) present the calculated power factor and weighted mobility μ_w as a function of temperature for the

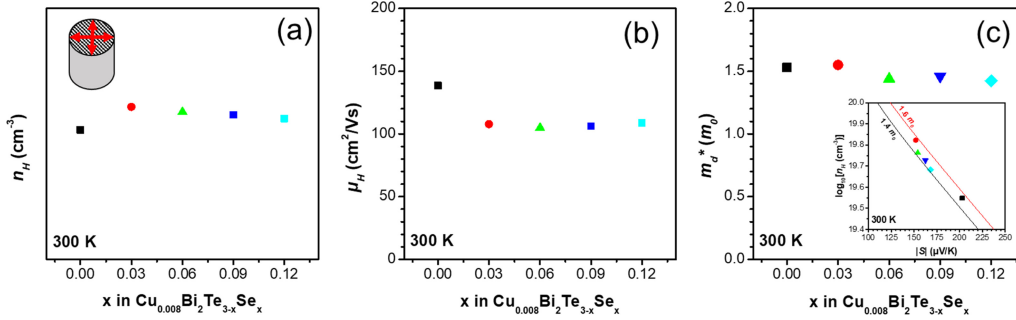


Fig. 3. (a) n_H and (b) μ_H (c) m_d^* as a function of the x content for the $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ ($x = 0, 0.03, 0.06, 0.09$ and 0.12) polycrystalline bulk alloys. Inset of (c) $\log_{10}(n_H)$ as a function of $|S|$ at 300 K.

$\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ samples. As shown in Figure 2(c), the power factor for the samples decreased with the increase in temperature. The power factor of the doped samples decreased in the temperature range of 300–400 K compared to the undoped sample. However, after 450 K, the $x = 0.03$ and 0.06 samples showed a reverse trend; the power factor of the $x = 0.03$ sample increased by approximately 10% compared to the undoped sample at 520 K. The power factor values of the $x = 0, 0.03,$ and 0.06 samples were 1.83, 1.99, and 1.92 mW/mK^2 at 520 K, respectively. The maximum power factor was 3.26 mW/mK^2 for the $x = 0$ sample at 300 K. The μ_w value was obtained from a simple analytical form that approximates the exact Drude–Sommerfeld free-electron model given in Equation (1) for $|S| > 20 \mu\text{V}/\text{K}$ [26].

$$\mu_w = \frac{3h^3\sigma}{8\pi e(2m_e kT)^{3/2}}$$

$$\left[\frac{\exp\left[\frac{|S|}{k/e} - 2\right]}{1 + \exp\left[-5\left(\frac{|S|}{k/e} - 1\right)\right]} + \frac{\frac{3}{\pi^2} \frac{|S|}{k/e}}{1 + \exp\left[5\left(\frac{|S|}{k/e} - 1\right)\right]} \right] \quad (1)$$

where k , m_e , e , and h are the Boltzmann constant, mass of the electron, elementary charge, and Planck's constant, respectively. The μ_w parameter infers the maximum reachable power factor when n_H is optimized. The μ_w value of each sample was evaluated using the measured σ and S parameters; the μ_w values showed a similar trend as the power factor. The maximum μ_w value was 373 cm^2/Vs for the $x = 0$ sample at 300 K.

Figure 3(a) shows n_H as a function of x for the $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ samples along the direction perpendicular to the sintering pressure. The n_H values showed a trend similar to the σ values; n_H increased approximately twice for the $x = 0.03$ ($6.66 \times 10^{19} \text{cm}^{-3}$) sample compared to the $x = 0$ ($3.54 \times 10^{19} \text{cm}^{-3}$) sample at 300 K and then decreased linearly with increases in x . The μ_H values for the Co-doped samples decreased because μ_H is inversely proportional to n_H ; however, unlike n_H , the μ_H values were constant after $x = 0.06$ (Figure 3(b)). The μ_H values for the $x = 0, 0.03, 0.06, 0.09,$ and 0.12 samples are 139, 108, 105, 106, and 109 cm^2/Vs at 300 K, respectively.

The magnitude of the density of states is directly related to the density-of-state effective mass m_d^* and the electrical transport behavior was interpreted in terms of changes in the electron structure by calculating m_d^* . Equation (2), which was optimized to a single parabolic band model, is used to plot m_d^* for the samples (Figure 3(c)) [27].

$$\log_{10}\left(\frac{m_d^* T}{300}\right) = \frac{2}{3} \log_{10}(n) - \frac{2}{3} [20.3 - (0.00508 \times |S|) + (1.58 \times 0.967^{|S|})] \quad (2)$$

The m_d^* value of the $x = 0.03$ ($1.55 m_0$) sample was larger than that of the $x = 0$ ($1.529 m_0$) sample at 300 K because m_d^* is proportional to both $|S|$ and n_H . This indicates that the decrease in $|S|$ for the $x = 0.03$ sample is less than the increase in n_H at 300 K. The inset of Figure 3(c) shows a plot of $\log_{10}(n_H)$ as a function of $|S|$ for the samples. The m_d^* becomes generally lower with the Co doping.

Figure 4(a) shows κ_{tot} as a function of temperature for the

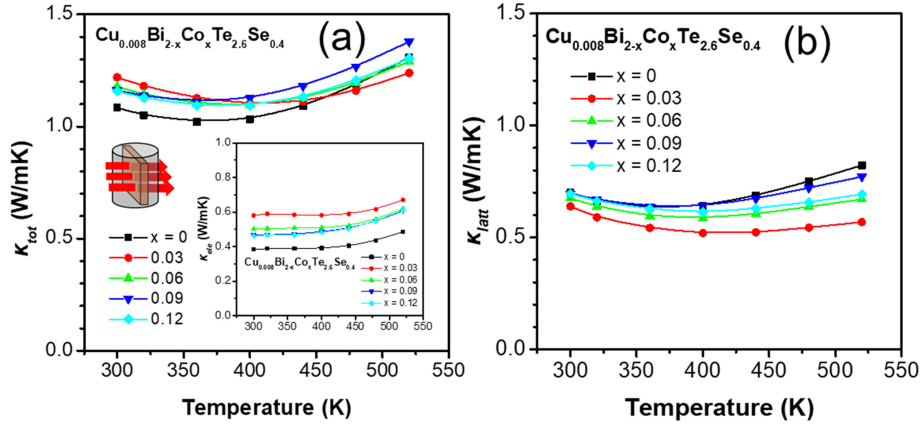


Fig. 4. (a) κ_{tot} and (b) κ_{latt} as a function of temperature for the $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ ($x = 0, 0.03, 0.06, 0.09$ and 0.12) polycrystalline bulk alloys. Inset of (a) κ_{ele} as a function of temperature.

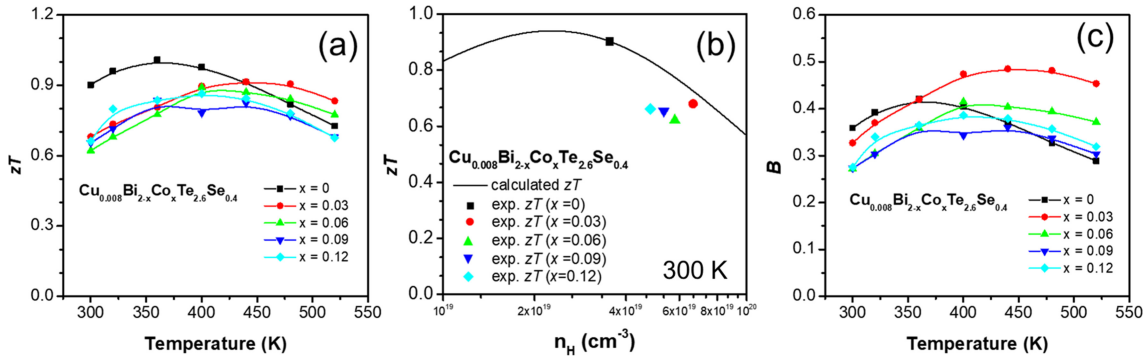


Fig. 5. (a) zT as a function of temperature for the $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ ($x = 0, 0.03, 0.06, 0.09$ and 0.12) polycrystalline bulk alloys. (b) n_H -dependent experimental zT (denoted using symbols) of $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ ($x = 0, 0.03, 0.06, 0.09$, and 0.12) and calculated zT (denoted using a line) via single parabolic band model. (c) B as a function of temperature for the $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ ($x = 0, 0.03, 0.06, 0.09$, and 0.12) polycrystalline bulk alloys.

$\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ samples along the direction perpendicular to the sintering pressure. The κ_{tot} values of the $x = 0.03, 0.06, 0.09$, and 0.12 samples at 300–450 K increased with the increase in κ_{ele} (inset of Figure 4(a)). The κ_{ele} values were calculated using $\kappa_{ele} = L\sigma T$ (where L is the Lorenz number [28]) and the increase in κ_{tot} significantly affected the increase in σ of the Co-doped samples. Therefore, the values of κ_{tot} for the $x = 0, 0.03, 0.06, 0.09$, and 0.12 samples at 300 K were 1.08, 1.22, 1.18, 1.16, and 1.16 W/mK, respectively. In contrast, the κ_{tot} values of the $x = 0.03, 0.06$, and 0.12 samples at 520 K decreased to 1.24, 1.29, and 1.31 W/mK, respectively, from that of the $x = 0$ (1.31 W/mK at 520 K) sample. Interestingly, the κ_{latt} reached its lowest value at $x = 0.03$, and increased for the higher doping samples. The physical reason behind the unusual observation for κ_{latt} may be the complex defect structures

produced by the Co doping, which requires further study.

Figure 5(a) illustrates the zT of the $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ polycrystalline bulk samples. The thermoelectric performance of the Co-doped samples significantly decreased in contrast to the undoped sample at 300 K. The maximum zT value of the undoped sample at 300 K was 1.0. However, the zT of the undoped sample decreased above 360 K, while those of the $x = 0.03$ and 0.06 samples marginally increased above 450 K. Therefore, the zT values of $x = 0.03$ and 0.06 were enhanced more than the $x = 0$ sample at 480 and 520 K. The zT values of the $x = 0.03$, and 0.06 samples were 0.91, and 0.84 at 480 K and 0.83, and 0.77 at 520 K, respectively. Further, the zT values of the $x = 0.03$ and 0.06 samples were enhanced to approximately 8% and 3% at 480 K and to approximately 15% and 7% at 520 K, compared with the $x = 0$ (0.82 and 0.72 at 480 and 520 K, respectively), respectively.

Figure 5(b) shows the n_H -dependent zT calculated via the single parabolic band model and experimental zT at 300 K; n_H -dependent experimental zT (denoted using symbols) and calculated zT (denoted using a line), which indicates the theoretically achievable zT at 300 K. The zT values of all the Co-doped samples were lower than the achievable zT (line in Figure 5(b)), which would infer the band structure was unfavorably changed by the doping. Because the n_H value of the $x = 0.03$ sample was the highest, it is plotted at the rightmost side (n_H of $6.7 \times 10^{19} \text{ cm}^{-3}$) in the graph (solid red). As the doping content increases, the symbols shift toward the left, which indicates a decrease in n_H . However, the peak value of the calculated zT was observed when n_H was $2.2 \times 10^{19} \text{ cm}^{-3}$. Therefore, n_H optimization of the samples is required. Based on the calculation, shown in Fig. 5(b), zT can be increased to 0.94 at 300 K when n_H is optimized (decreased) to $\sim 2.2 \times 10^{19} \text{ cm}^{-3}$. Dopants to decrease the mother compound $\text{Cu}_{0.008}\text{Bi}_2\text{Te}_{2.6}\text{Se}_{0.4}$ could be introduced to enhance zT at 300 K.

Figure 5(c) shows the dimensionless thermoelectric quality factor B , which was evaluated using Equation (3) [26]:

$$B = \left(\frac{k}{e}\right)^2 \frac{8\pi e(2m_e kT)^{3/2}}{3h^3} \cdot \frac{\mu_w}{\kappa_{latt}} T \quad (3)$$

Based on previous studies, B is proportional to the maximum zT value that can be achieved for an optimized n_H [29, 30]. Therefore, the general trend of B is similar to that of zT ; however, in this study, the $x=0.03$ sample has a maximum B value (0.49) at 440 K. In particular, the B values for all doped samples above 480 K were less than that of the undoped sample. The B values of the $x = 0, 0.03, 0.06, 0.09,$ and 0.12 samples were 0.29, 0.45, 0.37, 0.30, and 0.32, respectively, at 520 K. This indicates that in the Co-doped samples at 520 K, zT can be increased to a greater extent, when n_H is optimized.

4. CONCLUSIONS

In summary, the thermoelectric properties of Co-doped $\text{Bi}_2\text{Te}_{2.6}\text{Se}_{0.4}$, $\text{Cu}_{0.008}\text{Bi}_{2-x}\text{Co}_x\text{Te}_{2.6}\text{Se}_{0.4}$ ($x = 0, 0.03, 0.06, 0.09,$ and 0.12) polycrystalline samples were investigated. The electrical conductivity generally increased for the Co-doped samples and the S values decreased. The measured power

factor of the Co-doped samples was lower than 3.26 mW/mK^2 for the pristine $\text{Cu}_{0.008}\text{Bi}_2\text{Te}_{2.6}\text{Se}_{0.4}$ sample at 300 K. However, the power factor of the $\text{Cu}_{0.008}\text{Bi}_{1.97}\text{Co}_{0.03}\text{Te}_{2.6}\text{Se}_{0.4}$ ($x = 0.03$) sample became higher at 520 K. A decrease in lattice thermal conductivity was observed for the Co-doped samples due to additional point defect phonon scattering. Consequently, a maximum zT of 1.0 was observed for the $x = 0$ sample at 300 K; however, above 440 K, the zT values of the $x = 0.03$ and 0.06 samples were approximately 15% and 7% larger than that of the $x = 0$ sample, at 520 K, respectively. Furthermore, a maximum quality factor of 0.49 was observed for the $x = 0.03$ sample at 440 K, which would infer that the highest zT can be obtained with the $x = 0.03$ sample at 440 K by optimizing carrier concentration.

Conflict of interest statement

There is no conflict of interest.

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